

**PCN: V12-002-476103-OA**

## Product Change Notice

**Issue Date: 22-Mar-2012**









### Change Type:

Marking process – bottom mark elimination for SOIC devices

### Parts Affected:

HCTL-2022  
HCTL-2032-SC  
HCTL-2032-SCT

### Description and Extent of Change:

Lead Type	Current Marking	Proposed Marking	Dummy Proposed Sample Marking
SOM032	<p><b>TOP</b></p>  <p><b>BOTTOM</b></p> 		
PL020	<p><b>TOP</b></p>  <p><b>BOTTOM</b></p> 		

### Reasons for Change:

To improve cycle time, bottom marking is eliminated for SOIC packages on specific devices.

**Effect of Change on Fit, Form, Function, Quality, or Reliability:**

There will be no impact to product performance and the changes made are meant for cycle time improvement for marking operation.

**Effective Date of Change:**

Product shipment using this change will commence from 1-Jun-2012 and may vary depending on depletion of current inventory.

**Qualification Data:**

The validation data on the above improvements will be shared upon request.

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These changes have been reviewed and approved by Avago Technologies engineers and managers per Avago Technologies procedure.

Please contact your Avago Technologies field sales engineer or Contact Center (<http://www.avagotech.com/contact/>) for any questions or support requirements. Please return any response as soon as possible, but not to exceed 30 days.